

SEIKO EPSON CORPORATION



Specifications (characteristics)

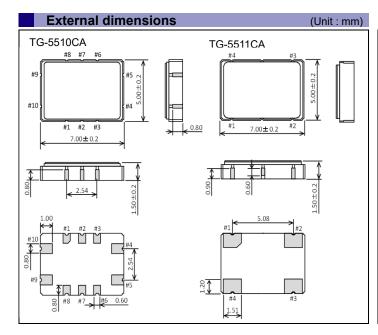
Item	Symbol	CMOS	Clipped sine wave	Condition
Output frequency range	fo	10 MHz to 54 MHz		Please contact us about available frequencies.
Supply voltage	V _{cc}	3.3 V ± 5 %		
Storage temperature	T stg	-40 °C to +105 °C		Storage as single product.
Operating temperature	T_use	-40 °C to +85 °C		Standard
		(-40 °C to +105 °C)		(Option)
a) Frequency tolerance	f_tol	±1.0 × 10 ⁻⁶ Max.		After reflow, +25 °C
b) Frequency/temperature	fo-Tc	±0.28 × 10 ⁻⁶ Max.		Standard
characteristics		(±0.25 × 10 ⁻⁶ Max.)		(Option)
c) Frequency/load coefficient	fo-Load	±0.1 × 10 ⁻⁶ Max.		Load ± 10 %
d) Frequency/voltage coefficient	fo-V _{cc}	±0.1 × 10 ⁻⁶ Max.		V _{CC} ± 5 %
e) Frequency aging	f age	±0.5 × 10 ⁻⁶ Max.		+25 °C, First year
,	i_aye	±3.0 × 10⁻ੰ Max.		+25 °C, 20 years
Holdover stability	_	±0.01 × 10 ⁻⁶ Max. (+25 °C, 24 hours)		After 10 days of continuous operation
(Constant temperature)	-	±0.04 × 10⁻ੰ Max.		After 48 hours of continuous operation
Wander generation (MTIE, TDEV)		Compliant with GR-1244CORE, ITU-T G.8262		
Free-run accuracy	-	±4.6 × 10 ⁻⁶ Max. / 20 years		This includes Item a), b), c), d) and e)
	Icc	7.0 mA Max.	6.0 mA Max.	$10 \text{ MHz} \le \text{fo} \le 26 \text{ MHz}$
Current consumption		9.0 mA Max.		26 MHz < fo \leq 40 MHz
		10.0 mA Max.		40 MHz < fo \leq 54 MHz
Symmetry	SYM	45 % to 55 %	-	GND level (DC cut)
Output voltage	V _{OH}	90 % V _{cc} Min.	-	
Oulput vollage	V _{OL}	10 % V _{cc} Max.	-	
Rise time / Fall time	tr/tf	8.0 ns Max.	-	10 % Vcc to 90 % Vcc level, Load: 15 pF
Start-up time	t_str	5 ms. Max.		t = 0 at 90 % V _{CC}
Output level	Vpp	-	0.8 V Min.	Peak to Peak
Output load condition	Load	15 pF	10 kΩ // 10 pF	
Input voltage	VIH	70% V _{cc} Min.		OE terminal (Enable voltage)
	VIL	30% V _{CC} Max.		OE terminal (Disable voltage)

* Note : Please contact us for requirements not listed in this specification.

 Product Name
 TG-5510CA-***
 30.720000MHz

 (Standard form)
 ①
 ②
 ③
 ④

0Model 2Package type 3Spec segment (Please contact us) 4Frequency



Footprint (Recommended) / Pin Map (Unit : mm) TG-5510CA TG-5511CA 3.88 3.88 1.27 1.27 #3 50 2.88 #8 ′#¤ 6 2.88 #1 #2 18 5.08 0.80 To maintain stable operation, provide a 0.01 µF to 0.1 µF by-pass capacitor at a location as near

as possible to the power source terminal of the crystal product (between V_{CC} - GND).

 Pin
 Connection

	1 11 1	Connection		
	1, 2, 3, 6, 7, 10	N.C.		
	4	GND		
	5	OUT		
	8	OE		
	9	Vcc		
OE pin = "H" or "open": Specified frequency ou				

Pin	Connection
1	N.C
2	GND
3	OUT
4	V _{cc}

OE pin = "H" or "open": Specified frequency output. OE pin = "L" : Output is high impedance.

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

Explanation of the mark that are using it for the catalog

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

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For Automotive	► Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
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Other applications requiring similar levels of reliability as the above

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